# **PATENT ASSIGNMENT COVER SHEET**

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6796606

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
CHONG CHEN	11/30/2020
JIN CHEN	12/16/2020
SHU LIN	12/01/2020
CHUNSHENG SUN	12/04/2020

#### **RECEIVING PARTY DATA**

Name:	HUAWEI TECHNOLOGIES CO., LTD.
Street Address:	HUAWEI ADMINISTRATION BUILDING
Internal Address:	BANTIAN, LONGGANG
City:	SHENZHEN, GUANGDONG
State/Country:	CHINA
Postal Code:	518129

## **PROPERTY NUMBERS Total: 1**

Property Type	Number	
Application Number:	17107588	

#### **CORRESPONDENCE DATA**

**Fax Number:** (416)362-0823

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 4168681482

**Email:** ridbee@ridoutmaybee.com

Correspondent Name: MATTHEW NORWOOD, RIDOUT & MAYBEE LLP

Address Line 1: 250 UNIVERSITY AVENUE

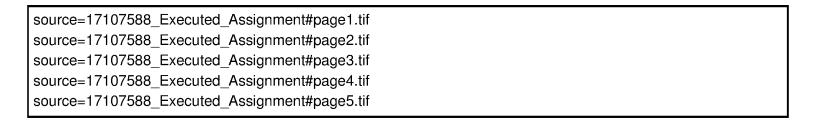
Address Line 2: 5TH FLOOR

Address Line 4: TORONTO, CANADA M5H 3E5

Total Attachments, 5	
DATE SIGNED:	07/05/2021
SIGNATURE:	/Marissa Manning/
NAME OF SUBMITTER:	MARISSA MANNING
ATTORNEY DOCKET NUMBER:	50874-3591

Total Attachments: 5

PATENT REEL: 056751 FRAME: 0913



PATENT REEL: 056751 FRAME: 0914

WHEREAS, I/We, the undersigned inventor(s) (or one of the undersigned joint inventors), of residence as listed below, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed in a way that effectively on the date that the application is filed or a priority date or priority dates that the application claims; and

WHEREAS, Huawei Technologies Co., Ltd. ("Assignee"), a corporation organized and existing under the laws of China, having a principal place of business at Huawei Administration Building, Bantian, Longgang, Shenzhen, Guangdong, 518129 China, is desirous of acquiring my/our entire right, title and interest in the said invention, and to the said application and any Letters Patent that may issue thereon in the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I/we will assign, and hereby assign and transfer to the Assignee and the Assignee's legal representatives, successors and assigns the full and exclusive right, title and interest in and to the invention in the United States and every other country and the entire right, title, and interest in and to the patent application and other such applications (e.g., provisional applications, non-provisional applications, continuations, continuations-in-part, divisional, reissues, reexaminations, National Phase applications, including petty patent applications, and utility model applications) that may be filed in the United States and every other country on the invention, and the patents, extensions, or derivations thereof, both foreign and domestic, that may issue thereon, and I/we do hereby authorize and request the Commissioner for Patents to issue U.S. patents for said invention, or patent resulting therefrom, insofar as my/our interest is concerned, to the Assignee agreeably with the terms of this assignment document.

I/we also hereby agree to sell and to assign, and sell and assign to Assignee, its successors and assigns, my/our international rights to the invention disclosed in said application, in all countries of the world, including, but not limited to, the right to file applications and obtain patents under the terms of any International Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I/we hereby further agree that I/we will communicate to Assignee, or its successors, assigns, and legal representative, any facts known to me/us respecting said invention or the file history thereof, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all documents required for divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid such Assignee, its successors,

Huawei Technologies Co., Ltd. Patent Reference No. 86963006US01 Page 1 of 3

assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

I/we hereby authorize Assignee to modify this Assignment at a later date for the purpose of adding information to better identify the invention, such as the application serial number, and filing date of a patent application filed thereon.

METHOD, APPARATUS AND MEDIUM FOR DATA

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year;

Title of Invention

Huawei Technologies Co., Ltd.

Patent Reference No. 86963006US01

	SYNCHRONIZATION BETWEEN CLOUD DATABASE		
	NODES		
	Appl. No.	Filing Date:	
	17/107,588	November 30, 2020	
\$;;;;			
Signature of Inventor:	<u></u>		
Inventor Name:	Chong CHEN	Date New 3 2 22	
Residence (City/State):	Richmond Hill/Ontario		
•	8		
Signature of Witness:	June		
Witness Name:	Jiwen Hus	Date Nov.30,2020	
Residence (City/State):	Richmond HW TON		
		-	
Signature of Inventor:		***************************************	
Inventor Name:	Jin CHEN	Date	
Residence (City/State):	Richmond Hill/Ontario	***************************************	
Signature of Witness:			
Witness Name:		Date	
Residence (City/State):			
Signature of Inventor:			
Inventor Name:	Shu LIN	Date	
Residence (City/State):	Richmond Hill/Ontario	***************************************	
Signature of Witness:			
Witness Name:		Date	
Residence (City/State):			

PATENT REEL: 056751 FRAME: 0916

Page 2 of 3

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assigns and nonunees to obtain and enforce proper potent protection for said 

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Title of Inventors	METHOD, APPARATUS AND MEDIUM FOR DATA SYNCHRONIZATION BETWEEN CLOUD DATABASE NODES		
	Appl. No. 17/107,588	Filing Cate November 30, 2020	
Security of Inventor Inventor Nation Residence (City/State)	Chang CHEN Listense Hill/Chinese	Nav	
Security of Wilness Witness Name: Seedings (City/State)		Date	
	Jin CHEN Richmond Hill Outsin		
	Shalls		

assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

I/we hereby authorize Assignee to modify this Assignment at a later date for the purpose of adding information to better identify the invention, such as the application serial number, and filing date of a patent application filed thereon.

METHOD, APPARATUS AND MEDIUM FOR DATA

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year;

	NODES			
	Appl. No.	Filing Date:		
	17/107,588	November 30, 2020		
Signature of Inventor:				
Inventor Name:	Chong CHEN	Date		
Residence (City/State):	Richmond Hill/Ontario			
Signature of Witness:				
Witness Name:		Date		
Residence (City/State):				
Signature of Inventor:				
Inventor Name:	Jin CHEN	Date		
Residence (City/State):	Richmond Hill/Ontario			
Signature of Witness:				
Witness Name:		Date		
Residence (City/State):		Date		
residence (only, state).				
G1	1.0			
Signature of Inventor:				
Inventor Name:	Shu LIN	Date	December 1st, 202	
Residence (City/State):	Richmond Hill/Ontario			

Huawei Technologies Co., Ltd. Patent Reference No. 86963006US01

Signature of Witness:

Residence (City/State):

Witness Name:

Tao He

Richmond Hill/Ontario

Tao HE

Title of Invention

Page 2 of 3

December 1st, 2020

Date

Signature of Inventor:	Chunsheng Sun		
Inventor Name:	Chunsheng SUN	Date	2020-12-04
Residence (City/State):	Markham/Ontario		
Signature of Witness:	Ning Xia		
Witness Name:	Ning XIA	Date	2020-12-04
Residence (City/State):	Markham/Ontario		

Huawei Technologies Co., Ltd. Patent Reference No. 86963006US01

**RECORDED: 07/05/2021** 

Page 3 of 3

PATENT REEL: 056751 FRAME: 0919